

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: 2823
Examiner: To be assigned

In Re PATENT APPLICATION OF:

Applicant(s) : Junichi HIKITA et al.

Serial No. : Not assigned: Divisional of 09/704,563

Filed : July 25, 2003

For : Method of producing a semiconductor
Device by dividing a semiconductor wafer
Into separate pieces of semiconductor chips
(as amended)

Attorney Ref: AI 290 D1

STATUS REQUEST

July 22, 2005

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450


Sir:

Please let us know the status of the above-identified application and when an
Action may be expected. If the response to this status request is made by telephone, please
ask for Tonya Harris (Docket Clerk) at extension 518.

Respectfully submitted,

July 22, 2005
Date

SMR:klc



Steven M. Rabin
Registration No. 29,102
Rabin & Berdo PC
Customer No. 23995
Tel: (202) 371-8976
Fax: (202) 408-0924